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# INTEGRATED CIRCUITS

# DATA SHEET

# **NE/SA5234**

Matched quad high-performance low-voltage operational amplifier

Product data Supersedes data of 2001 Aug 03 File under Integrated Circuits, IC11 Handbook 2002 Feb 22





# Matched quad high-performance low-voltage operational amplifier

**NE/SA5234** 

#### **DESCRIPTION**

The NE/SA5234 is a matched, low voltage, high performance quad operational amplifier. Among its unique input and output characteristics is the capability for both input and output rail-to-rail operation, particularly critical in low voltage applications. The output swings to less than 50 mV of both rails across the entire power supply range. The NE/SA5234 is capable of delivering 5.5 V peak-to-peak across a 600  $\Omega$  load and will typically draw only 700  $\mu$ A per amplifier. The bandwidth is 2.5 MHz and the 1% settling time is 1.4  $\mu$ s.

### **FEATURES**

- Wide common-mode input voltage range: 250 mV beyond both rails
- Output swing within 50 mV of both rails
- Functionality to 1.8 V typical
- Low current consumption: 700 μA per amplifier
- $\pm 15$  mA output current capability
- Unity gain bandwidth: 2.5 MHz
- Slew rate: 0.8 V/μs
- Low noise: 25 nV/√Hz
- Electrostatic discharge protection
- Short-circuit protection
- Output inversion prevention

#### PIN CONFIGURATION

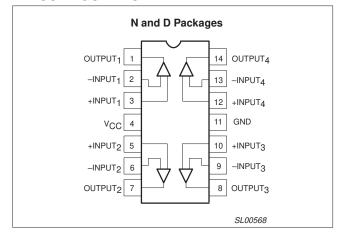


Figure 1. Pin configuration.

### **APPLICATIONS**

- Automotive electronics
- Signal conditioning and sensing amplification
- Portable instrumentation
  - Test and measurement
  - Medical monitors and diagnostics
  - Remote meters
- Audio equipment
- Security systems
- Communications
  - Pagers
  - Cellular telephone
  - LAN
  - 5 V Datacom bus
- Error amplifier in motor drives
- Transducer buffer amplifier

### **ORDERING INFORMATION**

DESCRIPTION	TEMPERATURE RANGE	ORDER CODE	DWG#
14-Pin Plastic Small Outline (SO) package	0 °C to +70 °C	NE5234D	SOT108-1
14-Pin Plastic Dual In-Line Package (DIP)	0 °C to +70 °C	NE5234N	SOT27-1
14-Pin Plastic Small Outline (SO) package	-40 °C to +85 °C	SA5234D	SOT108-1
14-Pin Plastic Dual In-Line Package (DIP)	-40 °C to +85 °C	SA5234N	SOT27-1

# Matched quad high-performance low-voltage operational amplifier

NE/SA5234

### **ABSOLUTE MAXIMUM RATINGS**

SYMBOL	PARAMETER	RATING	UNIT
V <sub>CC</sub>	Single supply voltage	7	V
V <sub>ESD</sub>	ESD protection voltage at any pin <sup>5</sup> human body model robot model	2000 200	V
V <sub>S</sub>	Dual supply voltage	±3.5	V
$V_{DP}$	Voltage at any device pin <sup>1</sup>	V <sub>S</sub> ±0.5	V
I <sub>DP</sub>	Current into any device pin <sup>1</sup>	±50	mA
V <sub>IN</sub>	Differential input voltage <sup>2</sup>	0.5	V
V <sub>CM</sub>	Common-mode input voltage (positive)	V <sub>CC</sub> + 0.5	V
V <sub>CM</sub>	Common-mode input voltage (negative)	V <sub>EE</sub> – 0.5	V
P <sub>D</sub>	Power dissipation <sup>3</sup>	500	mW
Tj	Operating junction temperature <sup>3</sup>	+150	°C
V <sub>SC</sub>	Supply voltage allowing indefinite output short circuit to either rail <sup>3,4</sup>	7	V
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C
T <sub>sld</sub>	Lead soldering temperature (10 sec max)	+230	°C
$\theta_{JA}$	Thermal impedance 14 pin Plastic DIP 14 pin Plastic SO	80 115	°C/W °C/W

#### NOTES:

- 1. Each pin is protected by ESD diodes. The voltage at any pin is limited by the ESD diodes.
- The differential input of each amplifier is limited by two internal diodes, connected in parallel and opposite to each other. For more differential input range, use differential resistors in series with the input pins.
- 3. The maximum operating junction temperature is +150 °C. At elevated temperatures, devices must be derated according to the package thermal resistance and device mounting conditions. Derates above +25 °C: N package at 9.5 mW/°C; D package at 6.25 mW/°C.
- 4. Simultaneous short circuits of two or more amplifiers to the positive or negative rail can exceed the power dissipation ratings and cause eventual destruction of the device.
- 5. Guaranteed by design.

# RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	RATING	UNIT
V <sub>CC</sub>	Single supply voltage	+2 to +5.5	V
V <sub>S</sub>	Dual supply voltage	±1 to ±2.75	V
V <sub>CM</sub>	Common-mode input voltage (positive)	V <sub>CC</sub> + 0.25	V
V <sub>CM</sub>	Common-mode input voltage (negative)	V <sub>EE</sub> – 0.25	V
T <sub>amb</sub>	Temperature NE5234 SA5234	0 to +70 -40 to +85	°C °C

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# Matched quad high-performance low-voltage operational amplifier

NE/SA5234

# DC ELECTRICAL CHARACTERISTICS

 $V_{CC} = 2 \text{ V to } 5.5 \text{ V}$ ;  $V_{FF} = 0 \text{ V}$ ;  $T_{amb} = 25 \text{ °C}$ ;  $V_{FF} < V_{CM} < V_{CC}$ ; unless otherwise stated.

		TECT COMPITIONS				ITS				
SYMBOL	PARAMETER	TEST CONDITIONS		NE5234	ļ		SA5234		UNIT	
			MIN	TYP	MAX	MIN	TYP	MAX		
		V <sub>CC</sub> = 5.5 V		2.8	4.0		2.8	4.0		
I <sub>CC</sub>	Supply current	V <sub>CC</sub> = 5.5 V over full temperature range		3.0	4.6		3.2	4.8	mA	
				±0.2	±4		±0.2	±4		
V <sub>OS</sub>	Offset voltage	Over full temperature range		±0.4	±5		±0.6	±5	mV	
$\Delta V_{OS}/\Delta T$	Offset voltage drift with temperature			4			4		μV/°C	
	Offset voltage difference between any amplifiers in			0.4	3		0.4	3		
$\Delta V_{OS}$	the same package at the same common mode level <sup>1</sup>	Over full temperature range		0.8	4		1.2	4	mV	
				±3	±20		±3	±30		
los	Offset current	Over full temperature range		±4	±30		±6	±60	nA	
$\Delta I_{OS}/\Delta T$	Offset current drift with temperature			0.02	±0.3		0.03	±0.3	nA/°C	
		$V_{EE} < V_{CM} < V_{EE} + 0.5 V$	-200	-90		-200	-90			
I <sub>B</sub>	Input bias current <sup>1</sup>	Over full temperature range	-225	-100		-250	-150		nA	
ıB	input bias current	$V_{EE}$ +1 V < $V_{CM}$ < $V_{CC}$		25	70		25	75		
		Over full temperature range		35	100		35	120		
$\Delta I_{\text{B}}/\Delta T$	Input bias current drift with temperature			0.5			0.5		nA/°C	
		$V_{EE} < V_{CM} < V_{EE} + 0.5V$		10	30		10	30		
$\Delta l_{B}$	Input bias current difference between any amplifier in the	Over full temperature range		25	50		50	70	nA	
	same package at the same common mode level.	$V_{EE}$ +1V < $V_{CM}$ < $V_{CC}$		5	20		5	20	'"`	
	oonmen mede level.	Over full temperature range		15	30		25	50		
		$V_{OS} \le 6 \text{ mV}$	V <sub>EE</sub> -0.25		V <sub>CC</sub> +0.25	V <sub>EE</sub> -0.25		V <sub>CC</sub> +0.25		
V <sub>CM</sub>	Common-mode input range	V <sub>OS</sub> ≤ 6 mV over full temperature range	V <sub>EE</sub> -0.1		V <sub>CC</sub> +0.1	V <sub>EE</sub> -0.1		V <sub>CC</sub> +0.1	٧	
	Common-mode rejection	$V_{EE} < V_{CM} < V_{EE} + 0.5 V;$ $V_{EE} + 1 V < V_{CM} < V_{CC}$	80	100		90	100			
CMRR	ratio, small signal	Over full temperature range	75			80			dB	
	Common-mode rejection	$V_{EE} < V_{CM} < V_{CC}$	65	90		65	100			
	ratio, large signal	Over full temperature range	60			60				
DODD	Davis and the state of the stat	$V_{EE} < V_{CM} < V_{CC}$	80	100		80	100			
PSRR	Power supply rejection ratio	Over full temperature range	80	90		80	90		dB	
	Peak load current, sink and		10	12		10	12			
ال	source	Over full temperature range	5	8		5	8		mA	

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# DC ELECTRICAL CHARACTERISTICS (Continued)

					LIM	IITS			
SYMBOL	PARAMETER	IETER TEST CONDITIONS					SA5234		UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
			90	110		90	110		
A <sub>VOL</sub>	Open-loop voltage gain	Over full temperature range		90			90		dB
		$I_{PEAK} = 0.1 \text{ mA}$	V <sub>EE</sub> +0.05		V <sub>CC</sub> -0.05	V <sub>EE</sub> +0.1		V <sub>CC</sub> -0.1	
	Output voltage swing	I <sub>PEAK</sub> = 10 mA	V <sub>EE</sub> +0.25		V <sub>CC</sub> -0.25	V <sub>EE</sub> +0.25		V <sub>CC</sub> -0.25	V
V <sub>OUT</sub>	3	I <sub>PEAK</sub> = 5 mA over full temperature range	V <sub>EE</sub> +0.22		V <sub>CC</sub> -0.2	V <sub>EE</sub> +0.2		V <sub>CC</sub> -0.2	
	Output voltage swing for	$R_L = 2 k\Omega$	V <sub>EE</sub> +0.2		V <sub>CC</sub> -0.2	V <sub>EE</sub> +0.2		V <sub>CC</sub> -0.2	V
	$V_{CC} = 2.75 \text{ V}; V_{EE} = -2.75 \text{ V}$	$R_L = 600 \Omega$	V <sub>EE</sub> +0.25		V <sub>CC</sub> -0.25	V <sub>EE</sub> +0.25		V <sub>CC</sub> -0.25	V

# NOTE:

# **AC ELECTRICAL CHARACTERISTICS**

 $T_{amb}$  = +25 °C;  $V_{CC}$  = 2 V to 5.5 V;  $R_L$  = 10 k $\Omega$ ;  $C_L$  = 100 pF; unless otherwise stated.

SYMBOL	PARAMETER	TEST CONDITIONS		NE5234		S	UNITS		
			MIN	TYP	MAX	MIN	TYP	MAX	
SR	Slew rate	Over full temperature range	0.5	0.8		0.5	0.8		V/μs
BW	Unity gain bandwidth: -3 dB	Over full temperature range	2	2.5	4.0	2	2.5	4.0	MHz
$\theta_{M}$	Phase Margin	C <sub>L</sub> = 50 pF		55			55		deg
t <sub>S</sub>	1% settling time	A <sub>V</sub> = 1, 1 V step		1.4			1.4		μs
V <sub>N</sub>	Input referred voltage noise	$A_V = 1$ ; $R_S = 0 \Omega$ , at 1 kHz		25			25		nV/Hz <sup>1/2</sup>
THD	Total harmonic distortion	10 kHz, 1 V <sub>P-P</sub> , A <sub>V</sub> = 1		0.1			0.1		%

# **OUTPUT INVERSION PREVENTION**

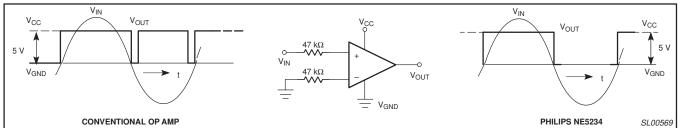


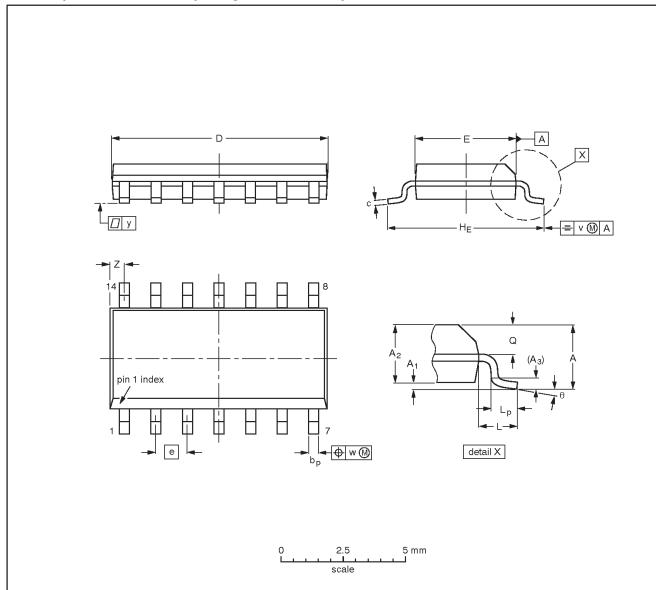
Figure 2. Output inversion prevention.

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These parameters are measured for V<sub>EE</sub> < V<sub>CM</sub> < V<sub>EE</sub>+0.5 V and for V<sub>EE</sub>+1 V < V<sub>CM</sub> < V<sub>CC</sub>. By design these parameters are intermediate for common mode ranges between the measured regions.

# SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	А3	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	>	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.35 0.34	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

#### Note

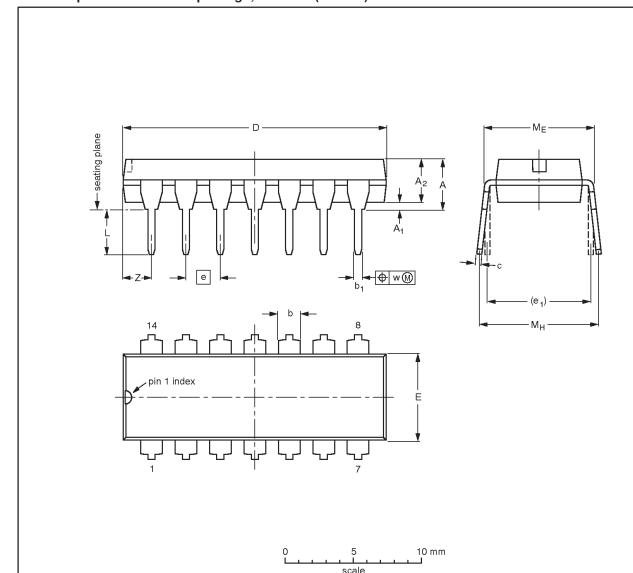
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012			<del>-97-05-22</del> 99-12-27

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DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



# DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	Мн	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFEF	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT27-1	050G04	MO-001	SC-501-14		<del>95-03-11</del> 99-12-27

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# Matched quad high-performance low-voltage operational amplifier

NE/SA5234

#### Data sheet status

Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup>	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development.  Philips Semiconductors reserves the right to change the specification in any manner without notice.
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